

mailto:processchange@centralsemi.com https://www.centralsemi.com/process-change-notices

# PCN # 237 Initial Notification Date: July 25, 2022

# **Product / Process Change Notice**

#### Part Affected:

The 2N6052 PNP power transistor.

# **Extent of Change:**

Change in assembly/test site and change in die size from 110 x 110 mils to 135 x 135 mils. The 2N6052 published data sheet has also been updated to include a Safe Operating Area (SOA) curve.

### Reason for Change:

As part of Central Semiconductor's supply chain risk mitigation initiative, and in an effort to ensure an undisrupted supply of product, a change to the assembly/test site and die size is being made for the product referenced above. Product specifications, quality and reliability are not impacted by this change.

## **Effect of Change:**

This change does not affect the fit, form or function of the device.

#### **Qualification:**

Based on standards JESD22 and MIL-STD-750, qualification testing is in-process and data will be provided upon successful completion.

#### **Earliest Effective Date of Change:**

To be determined after completion of qualification testing.

As per JEDEC standard JESD46, Customer Notification of Product/Process Changes by Solid-State Suppliers, a lack of acknowledgement of a PCN within thirty (30) days constitutes acceptance of the change.

The undersigned acknowledges and accepts Central Semiconductor's Product/Process Change Notification (PCN).

| Company Name: |  |
|---------------|--|
| Address:      |  |
|               |  |
| Printed Name: |  |
| Title:        |  |
| Signature:    |  |
| Date:         |  |

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